

# NP16N04YUG

R07DS0362EJ0100

Rev.1.00

Jun 13, 2011

## MOS FIELD EFFECT TRANSISTOR

### Description

The NP16N04YUG is N-channel MOS Field Effect Transistor designed for high current switching applications.

### Features

- Low on-state resistance  
—  $R_{DS(on)} = 25 \text{ m}\Omega \text{ MAX.}$  ( $V_{GS} = 10 \text{ V}$ ,  $I_D = 8 \text{ A}$ )
- Low  $C_{iss}$ :  $C_{iss} = 740 \text{ pF TYP.}$  ( $V_{DS} = 25 \text{ V}$ ,  $V_{GS} = 0 \text{ V}$ )
- Designed for automotive application and AEC-Q101 qualified
- Small size package 8-pin HSON

### Ordering Information

Part No.	Lead Plating	Packing		Package
NP16N04YUG-E1-AY *1	Pure Sn (Tin)	Tape 2500 p/reel	Taping (E1 type)	8-pin HSON
NP16N04YUG-E2-AY *1			Taping (E2 type)	

Note: \*1. Pb-free (This product does not contain Pb in the external electrode.)

### Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ )

Item	Symbol	Ratings	Unit
Drain to Source Voltage ( $V_{GS} = 0 \text{ V}$ )	$V_{DSS}$	40	V
Gate to Source Voltage ( $V_{DS} = 0 \text{ V}$ )	$V_{GSS}$	$\pm 20$	V
Drain Current (DC) ( $T_C = 25^\circ\text{C}$ )	$I_{D(DC)}$	$\pm 16$	A
Drain Current (pulse) *1	$I_{D(pulse)}$	$\pm 48$	A
Total Power Dissipation ( $T_C = 25^\circ\text{C}$ )	$P_{T1}$	36	W
Total Power Dissipation ( $T_A = 25^\circ\text{C}$ ) *2	$P_{T2}$	1.0	W
Channel Temperature	$T_{ch}$	175	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-55 to +175	$^\circ\text{C}$
Repetitive Avalanche Current *3	$I_{AR}$	13	A
Repetitive Avalanche Energy *3	$E_{AR}$	12	mJ

### Thermal Resistance

Channel to Case Thermal Resistance  $R_{th(ch-C)}$  4.17  $^\circ\text{C/W}$

Channel to Ambient Thermal Resistance \*2  $R_{th(ch-A)}$  150  $^\circ\text{C/W}$

Notes: \*1.  $T_C = 25^\circ\text{C}$ ,  $PW \leq 10 \mu\text{s}$ , Duty Cycle  $\leq 1\%$

\*2. Mounted on glass epoxy substrate of 40 mm x 40 mm x 1.6 mm with 4% copper area (35  $\mu\text{m}$ )

\*3.  $T_{ch(peak)} \leq 150^\circ\text{C}$ ,  $R_G = 25 \Omega$

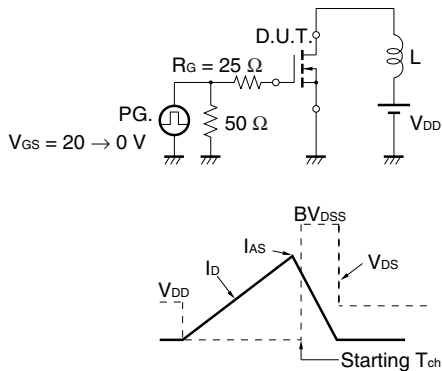
**Caution** This product is an electrostatic-sensitive device due to low ESD capability and should be handled with caution for electrostatic discharge. HBM (C = 100 pF, R = 1.5 k $\Omega$ )  $\pm 500 \text{ V}$ .

**Electrical Characteristics (T<sub>A</sub> = 25°C)**

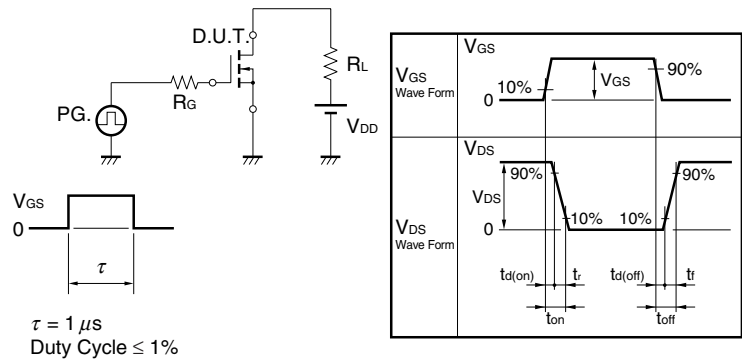
Item	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions
Zero Gate Voltage Drain Current	I <sub>DSS</sub>			1	μA	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V
Gate Leakage Current	I <sub>GSS</sub>			±100	nA	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V
Gate to Source Threshold Voltage	V <sub>GS(th)</sub>	2.0	3.0	4.0	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA
Forward Transfer Admittance *1	y <sub>fs</sub>	4	8		S	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 8 A
Drain to Source On-state Resistance *1	R <sub>DS(on)</sub>		20	25	mΩ	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A
Input Capacitance	C <sub>iss</sub>		740	1110	pF	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz
Output Capacitance	C <sub>oss</sub>		83	110	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>		57	100	pF	
Turn-on Delay Time	t <sub>d(on)</sub>		10	20	ns	V <sub>DD</sub> = 20 V, I <sub>D</sub> = 8 A, V <sub>GS</sub> = 10 V, R <sub>G</sub> = 0 Ω
Rise Time	t <sub>r</sub>		4	10	ns	
Turn-off Delay Time	t <sub>d(off)</sub>		19	38	ns	
Fall Time	t <sub>f</sub>		5	13	ns	
Total Gate Charge	Q <sub>G</sub>		16	24	nC	V <sub>DD</sub> = 32 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 16 A
Gate to Source Charge	Q <sub>GS</sub>		5		nC	
Gate to Drain Charge	Q <sub>GD</sub>		6		nC	
Body Diode Forward Voltage *1	V <sub>F(S-D)</sub>		0.9	1.5	V	I <sub>F</sub> = 16 A, V <sub>GS</sub> = 0 V
Reverse Recovery Time	t <sub>rr</sub>		25		ns	I <sub>F</sub> = 16 A, V <sub>GS</sub> = 0 V,
Reverse Recovery Charge	Q <sub>rr</sub>		24		nC	di/dt = 100 A/μs

Note: \*1. Pulsed test

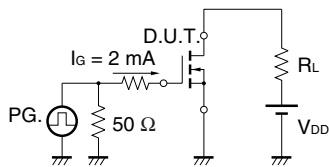
**TEST CIRCUIT 1 AVALANCHE CAPABILITY**



**TEST CIRCUIT 2 SWITCHING TIME**

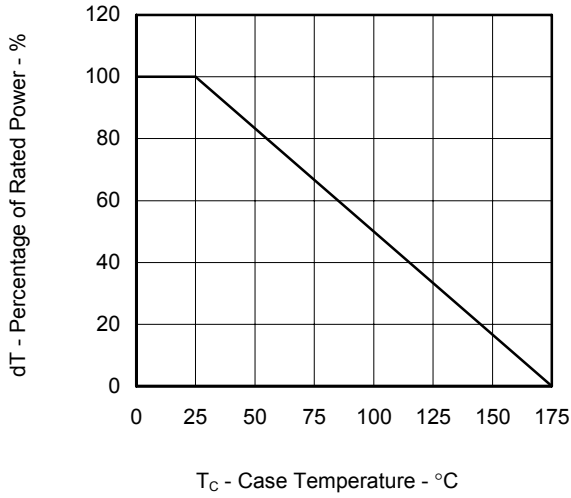


**TEST CIRCUIT 3 GATE CHARGE**

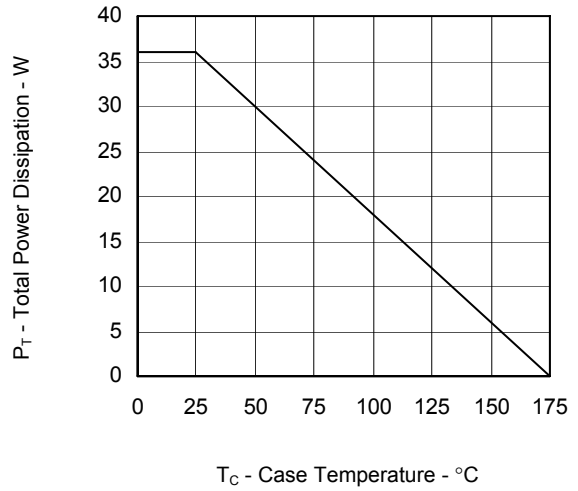


Typical Characteristics (T<sub>A</sub> = 25°C)

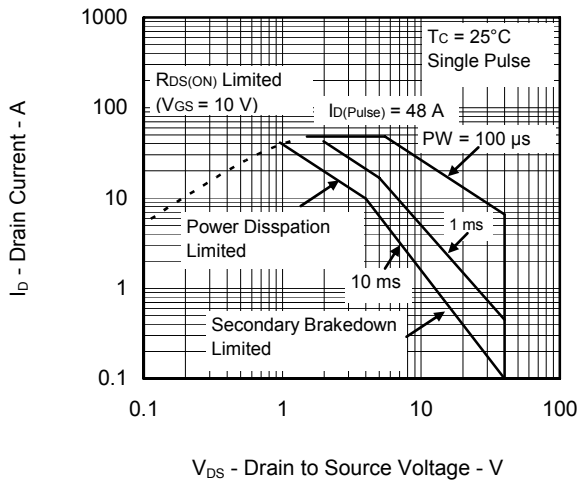
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



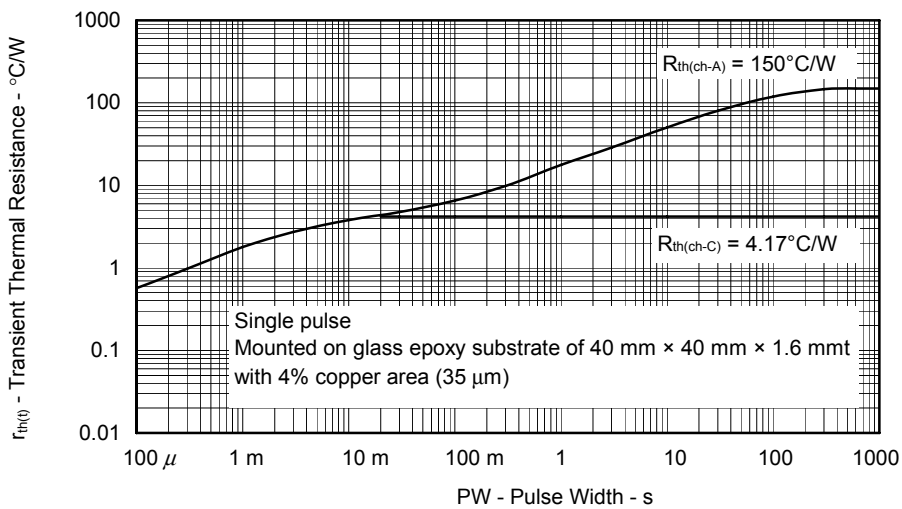
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



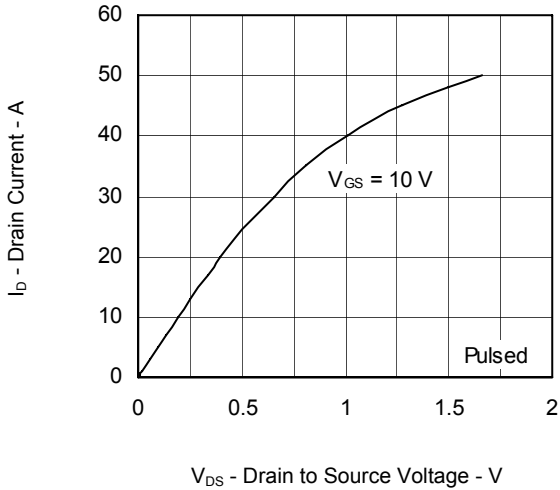
FORWARD BIAS SAFE OPERATING AREA



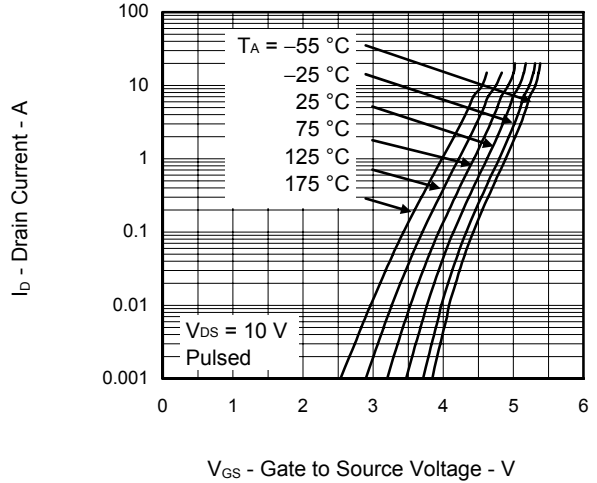
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



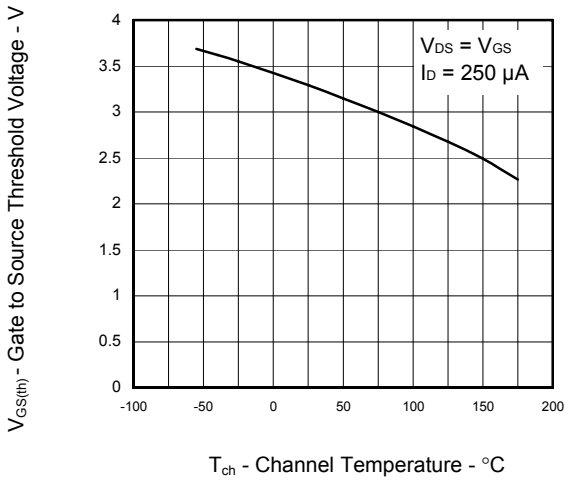
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



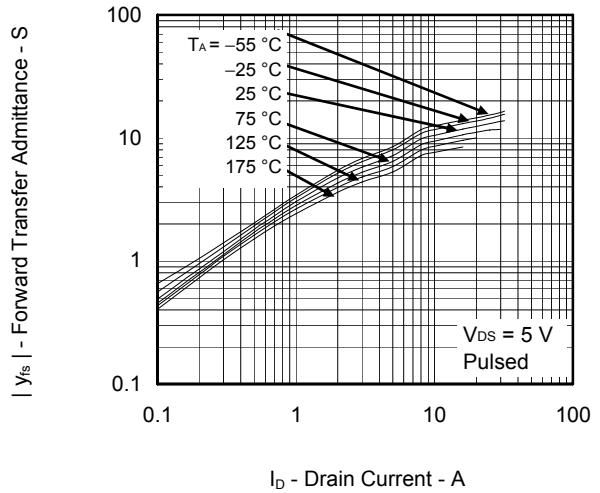
FORWARD TRANSFER CHARACTERISTICS



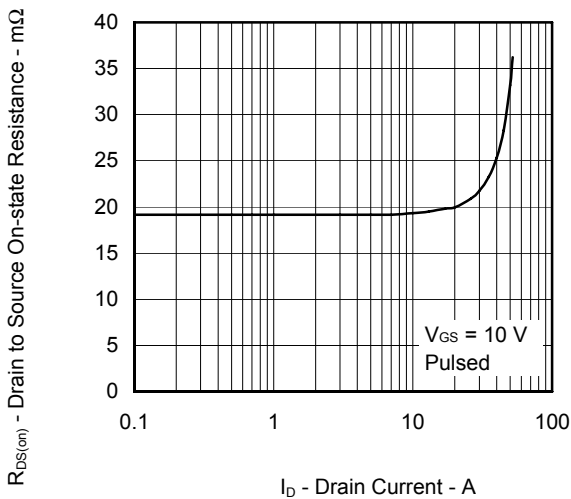
GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE



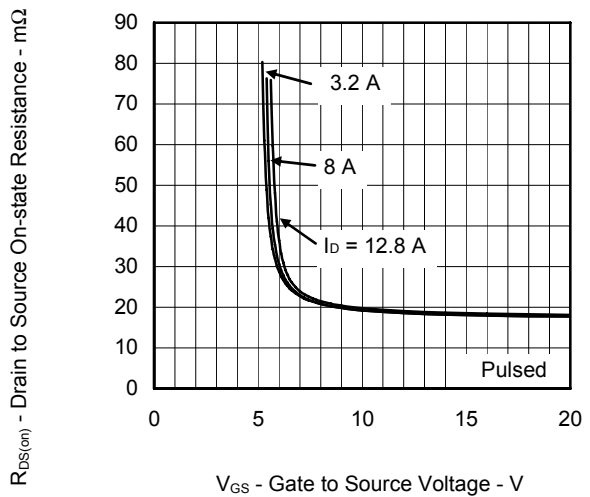
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



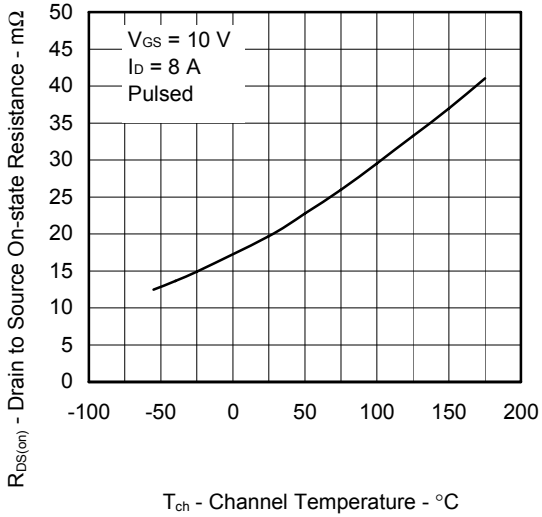
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



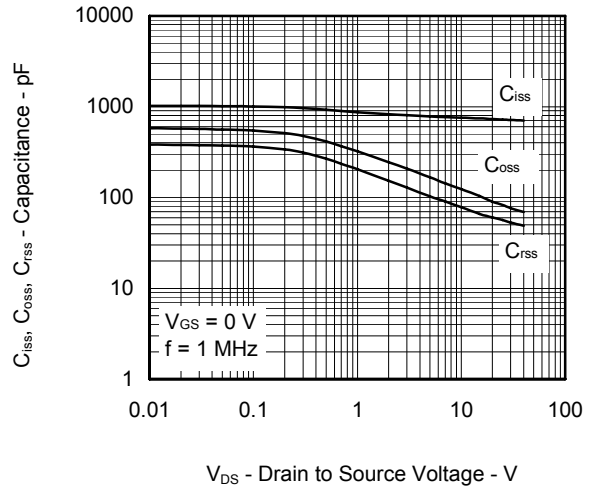
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



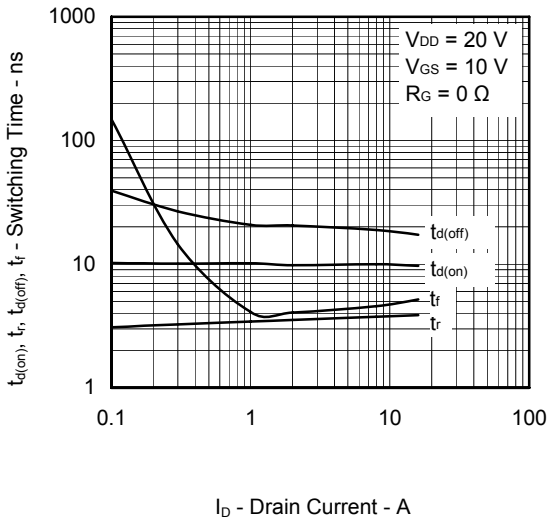
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



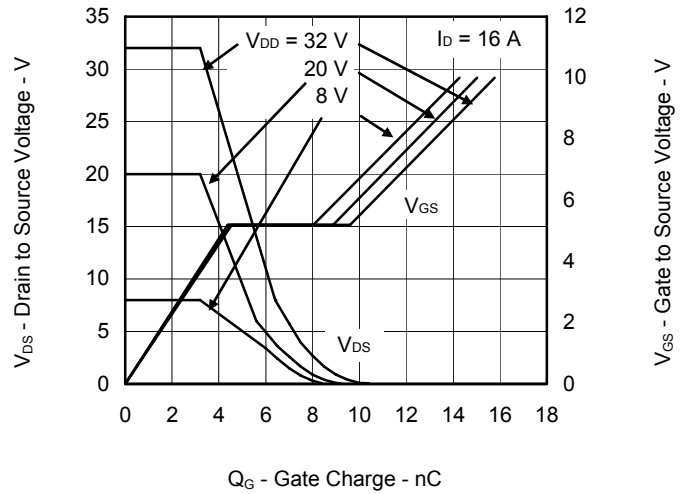
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



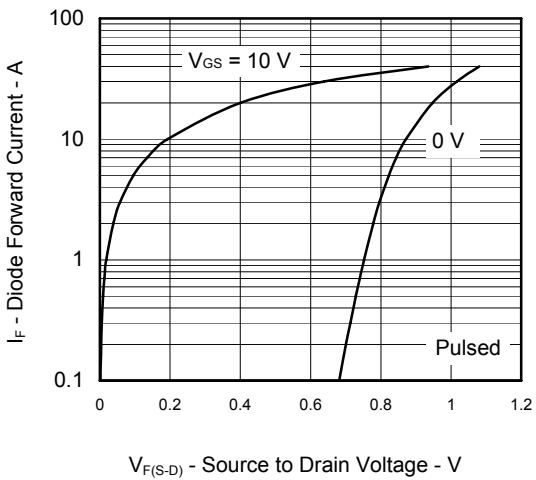
SWITCHING CHARACTERISTICS



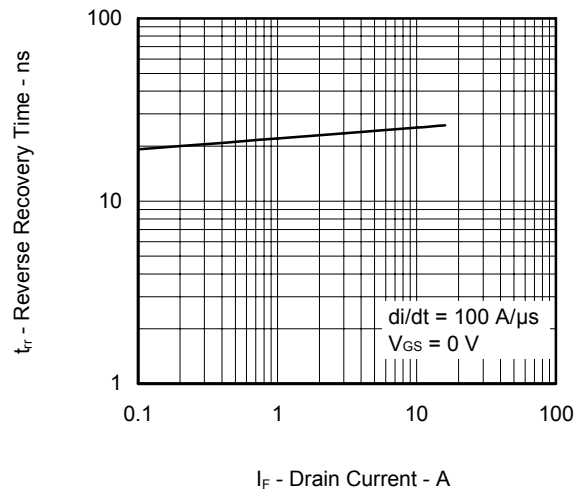
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE

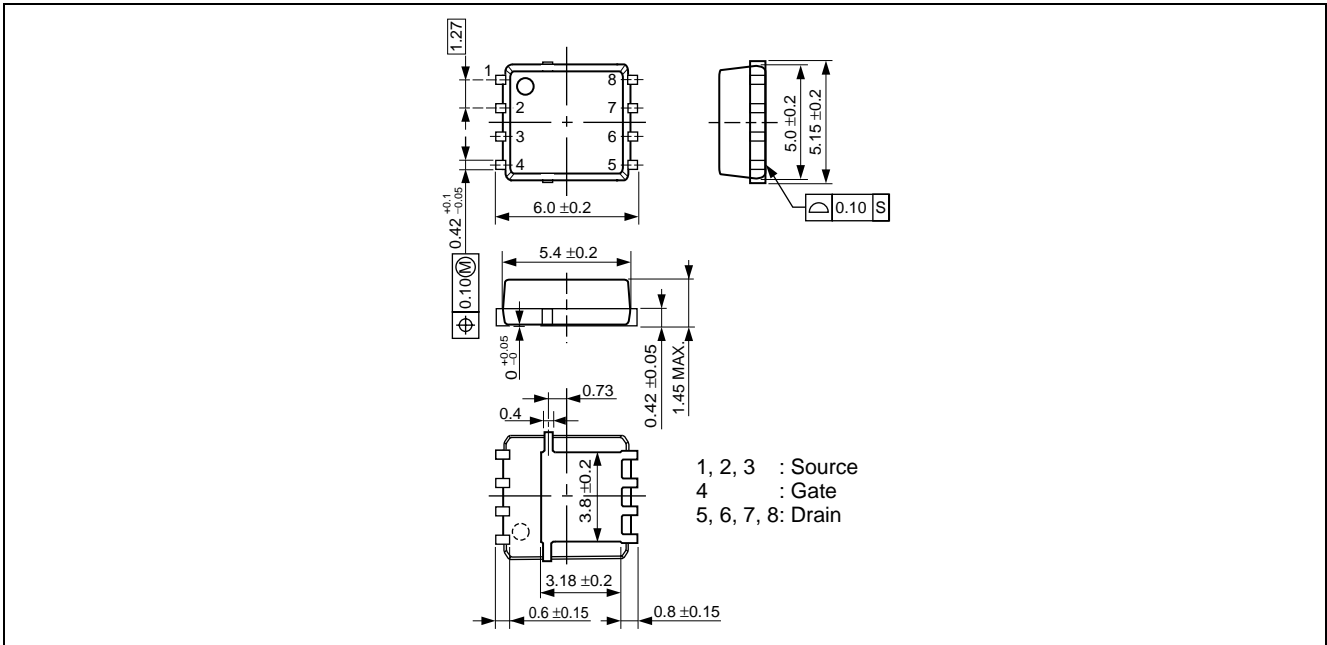


REVERSE RECOVERY TIME vs. DRAIN CURRENT

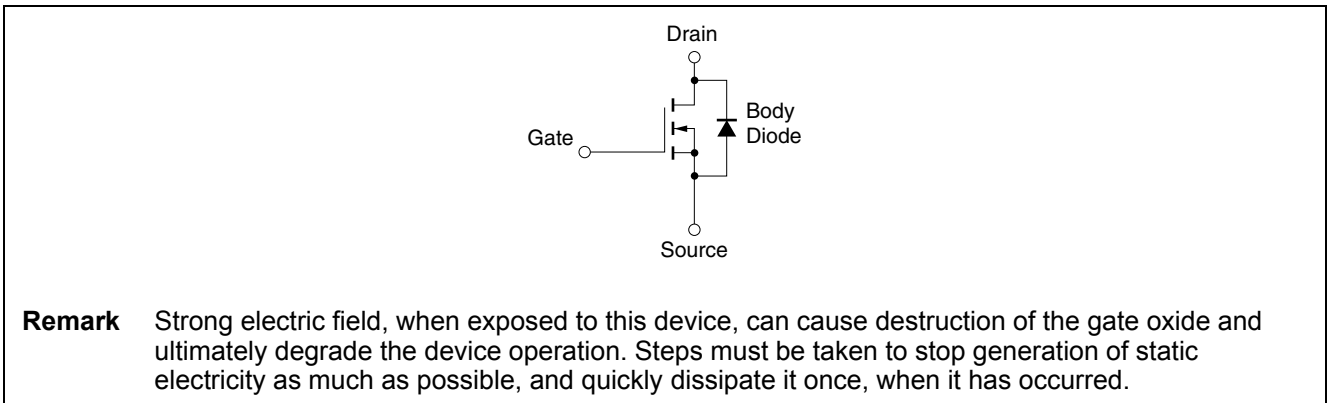


Package Drawings (Unit: mm)

8-pin HSON (Mass: 0.13 g TYP.)



Equivalent Circuit



**Remark** Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

<b>Revision History</b>	<b>NP16N04YUG Data Sheet</b>
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Rev.	Date	Description	
		Page	Summary
1.00	Jun 13, 2011	-	First Edition Issued

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**Renesas Electronics Canada Limited**  
1101 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada  
Tel: +1-905-898-5441, Fax: +1-905-898-3220

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Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.  
Tel: +44-1628-585-100, Fax: +44-1628-585-900

**Renesas Electronics Europe GmbH**  
Arcadiastrasse 10, 40472 Düsseldorf, Germany  
Tel: +49-211-65030, Fax: +49-211-6503-1327

**Renesas Electronics (China) Co., Ltd.**  
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Tel: +86-21-5877-1818, Fax: +86-21-6887-7858 / -7898

**Renesas Electronics Hong Kong Limited**  
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong  
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